

## N-Channel Super Junction Power MOSFET $\, \mathrm{I\!V}$

#### **General Description**

The series of devices use advanced trench gate super junction technology and design to provide excellent R<sub>DS(ON)</sub> with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

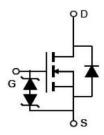
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- New technology for high voltage device
- Low on-resistance and low conduction losses
- ●Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ROHS compliant

Ap	a	lic	ati	on

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)

V <sub>DS min@Tjmax</sub>	710	V
R <sub>DS(ON)TYP</sub> .	410	mΩ
$I_D$	9	Α
Qg	12	nC



**Schematic diagram** 

#### **Package Marking And Ordering Information**

Device	Device Package	Marking
NCE65N460	TO-220-3L	NCE65N460



TO-220

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Table 1. Absolute Maximum Ratings (T<sub>c</sub>=25℃)

Parameter	Symbol	Value	Unit
Drain-Source Voltage (Vgs=0V)	V <sub>DS</sub>	650	V
Gate-Source Voltage (V <sub>DS</sub> =0V) ,AC (f>1 Hz)	Vgs	±30	V
Gate-Source Voltage (V <sub>DS</sub> =0V) ,DC	V <sub>G</sub> s	±20	V
Continuous Drain Current at Tc=25°C	I <sub>D (DC)</sub>	9	Α
Continuous Drain Current at Tc=100°C	I <sub>D (DC)</sub>	6.3	Α
Pulsed drain current (Note 1)	I <sub>DM (pluse)</sub>	27	Α
Maximum Power Dissipation(Tc=25℃)	P <sub>D</sub>	100	W
Derate above 25°C		0.67	W/°C
Single pulse avalanche current (Note 2)	I <sub>AS</sub>	2.5	Α
Reverse diode dv/dt, $V_{DS} \leq 480 \text{ V,I}_{SD} < I_{D}$	dv/dt	15	V/ns
Drain Source voltage slope,V <sub>DS</sub> ≤480 V	dv/dt	50	V/ns
Operating Junction and Storage Temperature Range	T <sub>J</sub> ,T <sub>STG</sub>	-55+175	°C



#### **Table 2. Thermal Characteristic**

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (Maximum)	R <sub>thJC</sub>	1.5	°C /W
Thermal Resistance, Junction-to-Ambient (Maximum)	R <sub>thJA</sub>	62	°C /W

Table 3. Electrical Characteristics (TA=25<sup>o</sup>Cunless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250uA	650			V
Zero Gate Voltage Drain Current(Tc=25℃)	I <sub>DSS</sub>	V <sub>DS</sub> =650V,V <sub>GS</sub> =0V			1	μA
Zero Gate Voltage Drain Current(Tc=125℃)	I <sub>DSS</sub>	V <sub>DS</sub> =650V,V <sub>GS</sub> =0V			100	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V			±200	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},I_{D}=250uA$	3	3.5	4	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =4.5A		410	460	mΩ
Dynamic Characteristics			1			
Gate Resistance	Rg	F=1MHZ, D-S short		40		Ω
Input Capacitance	C <sub>lss</sub>	., 50,414 014		530		pF
Output Capacitance	Coss	$V_{DS}$ =50V, $V_{GS}$ =0V,		25		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	F=1MHz		5.6		pF
Total Gate Charge	Qg			12		nC
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS}$ =380 $V$ , $I_{D}$ =4.5 $A$ ,		5.7		nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V		1.4		nC
Gate plateau voltage	Vgp			5.6		V
Switching times						
Turn-on Delay Time	t <sub>d(on)</sub>			9		nS
Turn-on Rise Time	tr	$V_{DD}$ =400 $V$ , $I_{D}$ =4.5 $A$ ,		6		nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_G$ =4 $\Omega$ , $V_{GS}$ =10 $V$		52		nS
Turn-Off Fall Time	t <sub>f</sub>			8		nS
Source- Drain Diode Characteristics			1			
Source-drain current(Body Diode)	I <sub>SD</sub>	T 05°0			9	Α
Pulsed-Source-drain current(Body Diode)	I <sub>SDM</sub>	T <sub>C</sub> =25°C			27	Α
Forward on voltage	V <sub>SD</sub>	Tj=25°C,I <sub>SD</sub> =9A,V <sub>GS</sub> =0V		0.9	1.2	V
Reverse Recovery Time	t <sub>rr</sub>			195		nS
Reverse Recovery Charge	Q <sub>rr</sub>	Tj=25°C,I <sub>F</sub> =4.5A,		1.36		uC
Peak reverse recovery current	I <sub>rrm</sub>	di/dt=100A/µs		14		Α

Notes: 1. Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25  $^{\circ}\text{C}$  ,VDD=50V,VG=10V, RG=25 $\Omega$ 



#### TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure 1. Output characteristics

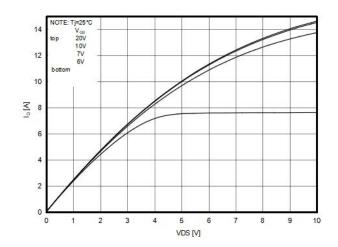


Figure 2. Transfer characteristics

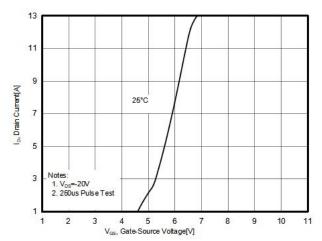


Figure 3. R<sub>DS(ON)</sub> vs Junction Temperature

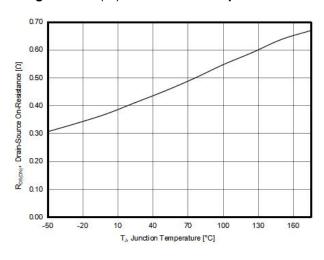


Figure 4. BV<sub>DSS</sub> vs Junction Temperature

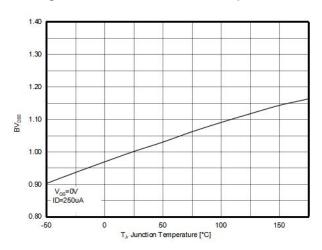


Figure 5. Maximum ID vs Junction Temperature

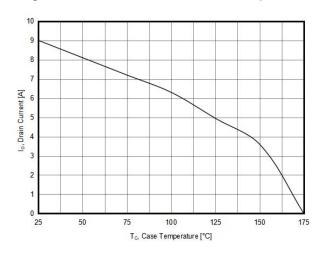
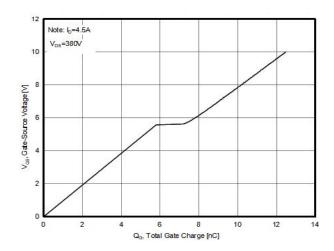


Figure 6. Gate charge waveforms



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Figure 7. Static drain-source on resistance

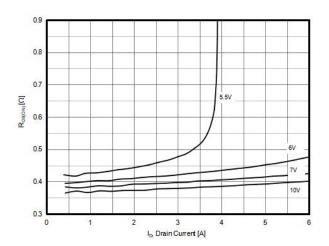


Figure9. Capacitance

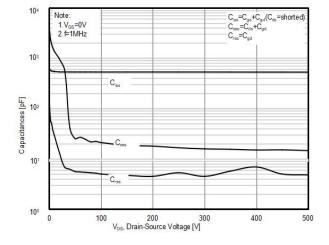


Figure8. Source-Drain Diode Forward Voltage

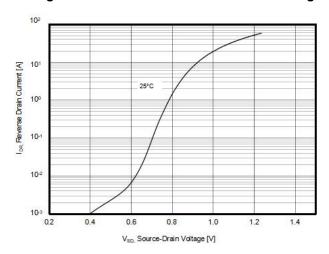
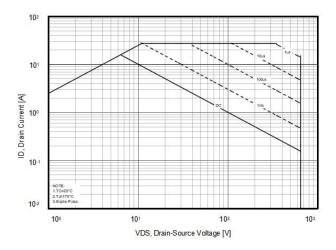


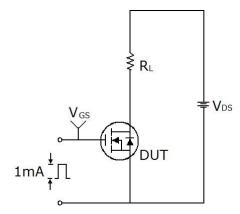
Figure 10. Safe operating area

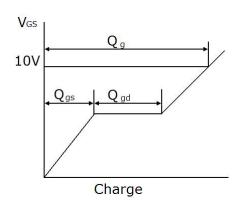




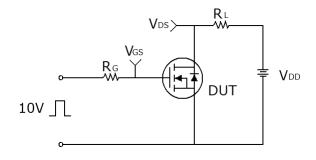
### **Test circuit**

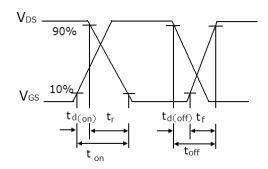
#### 1) Gate charge test circuit & Waveform



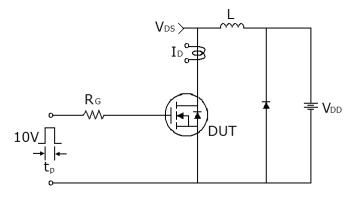


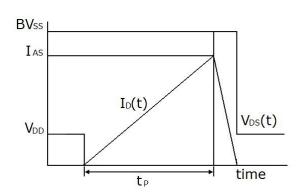
#### 2) Switch Time Test Circuit:





#### 3) Unclamped Inductive Switching Test Circuit & Waveforms

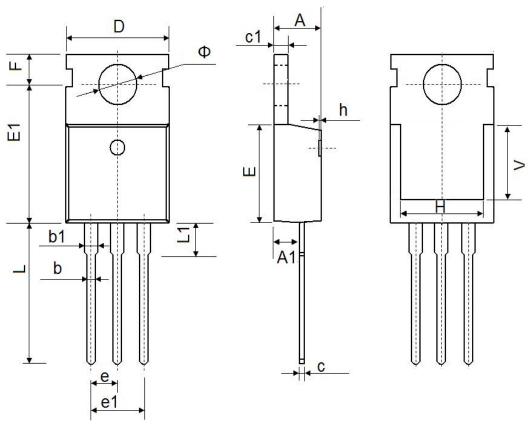




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# **TO-220-3L-E** Package Information



Comphal	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	4.20	4.60	0.165	0.181	
A1	2.25	2.55	0.089	0.100	
b	0.70	0.90	0.028	0.035	
b1	1.17	1.37	0.046	0.054	
С	0.33	0.65	0.013	0.026	
c1	1.20	1.40	0.047	0.055	
D	8.95	9.75	0.352	0.384	
E	9.74	10.04	0.352	0.384	
E1	9.91	10.25	0.390	0.404	
е	2.54BSC		0.100	BSC	
e1	5.08BSC		0.200BSC		
Н	15.45	15.85	0.608	0.624	
L	12.90	13.40	0.508	0.528	
L1	2.85	3.25	0.112	0.128	
Ф	3.40	3.80	0.134	0.150	

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